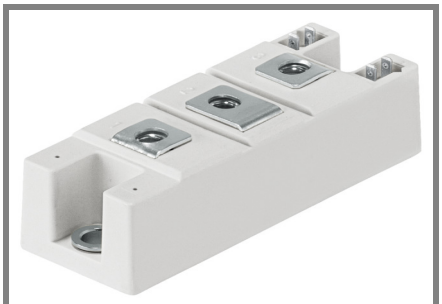
SKKT 162, SKKH 162



SEMIPACK® 2

Thyristor / Diode Modules

SKKT 162

SKKH 162

Features

- Heat transfer through aluminium oxide ceramic isolated metal baseplate
- Hard soldered joints for high reliability
- UL recognized, file no. E 63 532

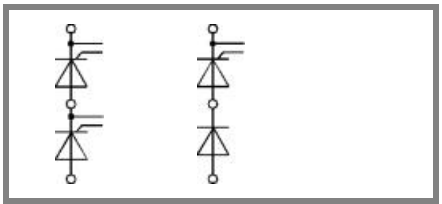
Typical Applications*

- DC motor control (e. g. for machine tools)
- Temperature control (e. g. for ovens, chemical processes)
- Professional light dimming (studios, theaters)

1) See the assembly instructions

V_{RSM} V	V_{RRM}, V_{DRM} V	I_{TRMS} = 250 A (maximum value for continuous operation) I_{TAV} = 160 A (sin.180; T_c = 83 °C)		
1300	1200	SKKT 162/12 E	SKKH 162/12 E	
1700	1600	SKKT 162/16 E	SKKH 162/16 E	
1900	1800	SKKT 162/18 E	SKKH 162/18 E	

Symbol	Conditions	Values	Units
I_{TAV}	sin. 180; T_c = 85 (100) °C;	156 (110)	A
I_D	P3/180F; T_a = 35 °C; B2 / B6	190 / 230	A
I_{RMS}	P3/180F; T_a = 35 °C; W1 / W3	265 / 3 * 185	A
I_{TSM}	T_{vj} = 25 °C; 10 ms	5400	A
	T_{vj} = 125 °C; 10 ms	5000	A
i²t	T_{vj} = 25 °C; 8,3 ... 10 ms	145000	A²s
	T_{vj} = 125 °C; 8,3 ... 10 ms	125000	A²s
V_T	T_{vj} = 25 °C; I_T = 500 A	max. 1,6	V
$V_{T(TO)}$	T_{vj} = 125 °C	max. 0,85	V
r_T	T_{vj} = 125 °C	max. 1,5	mΩ
I_{DD}; I_{RD}	T_{vj} = 125 °C; V_{RD} = V_{RRM}; V_{DD} = V_{DRM}	max. 40	mA
t_{gd}	T_{vj} = 25 °C; I_G = 1 A; di_G/dt = 1 A/µs	1	µs
t_{gr}	V_D = 0,67 * V_{DRM}	2	µs
$(di/dt)_{cr}$	T_{vj} = 125 °C	max. 200	A/µs
$(dv/dt)_{cr}$	T_{vj} = 125 °C	max. 1000	V/µs
t_q	T_{vj} = 125 °C ,	50 ... 150	µs
I_H	T_{vj} = 25 °C; typ. / max.	150 / 400	mA
I_L	T_{vj} = 25 °C; R_G = 33 Ω; typ. / max.	300 / 1000	mA
V_{GT}	T_{vj} = 25 °C; d.c.	min. 2	V
I_{GT}	T_{vj} = 25 °C; d.c.	min. 150	mA
V_{GD}	T_{vj} = 125 °C; d.c.	max. 0,25	V
I_{GD}	T_{vj} = 125 °C; d.c.	max. 10	mA
$R_{th(j-c)}$	cont.; per thyristor / per module	0,17 / 0,085	K/W
$R_{th(j-c)}$	sin. 180; per thyristor / per module	0,18 / 0,09	K/W
$R_{th(j-c)}$	rec. 120; per thyristor / per module	0,2 / 0,1	K/W
$R_{th(c-s)}$	per thyristor / per module	0,1 / 0,05	K/W
T_{vj}		- 40 ... + 125	°C
T_{stg}		- 40 ... + 125	°C
V_{isol}	a. c. 50 Hz; r.m.s.; 1 s / 1 min.	3600 / 3000	V~
M_s	to heatsink	5 ± 15 %[1)]	Nm
M_t	to terminal	5 ± 15 %	Nm
a		5 * 9,81	m/s²
m	approx.	165	g
Case	SKKT	A 21	
	SKKH	A 22	



SKKT SKKH

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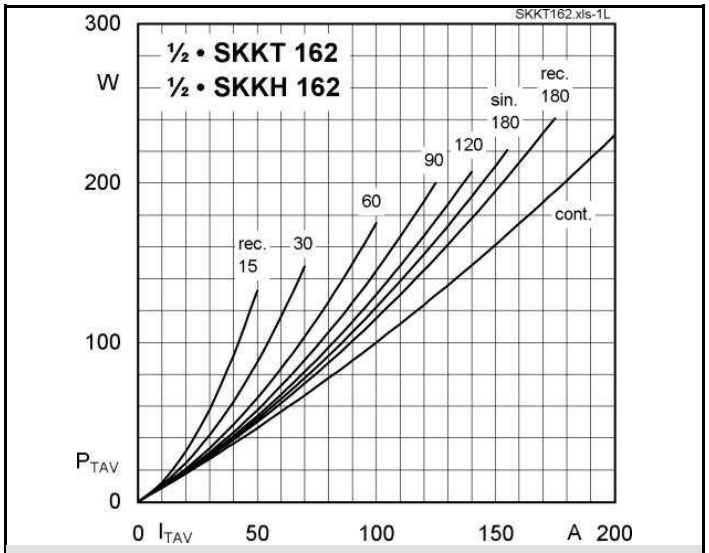

Fig. 1L Power dissipation per thyristor vs. on-state current

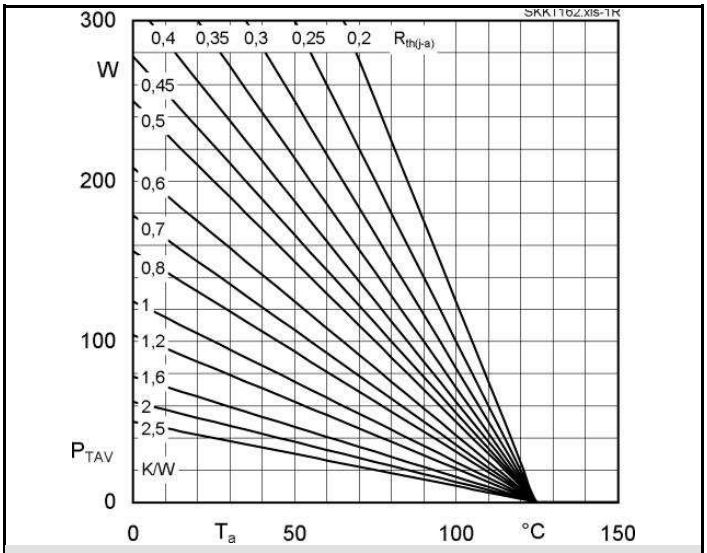

Fig. 1R Power dissipation per thyristor vs. ambient temp.

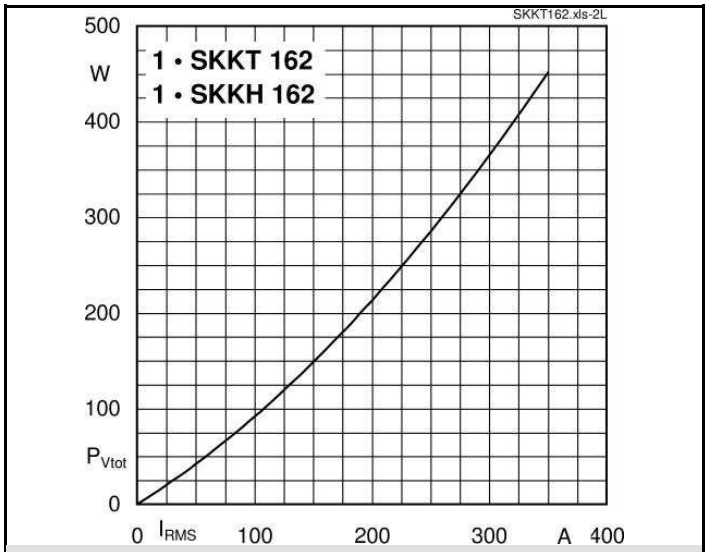

Fig. 2L Power dissipation per module vs. rms current

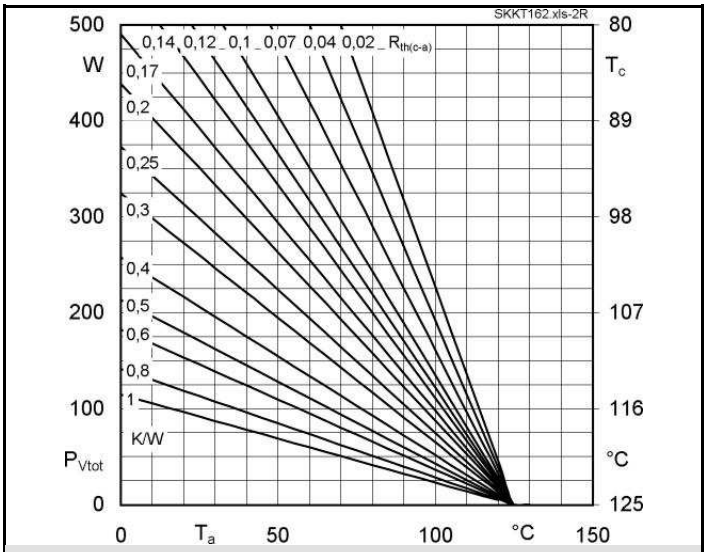

Fig. 2R Power dissipation per module vs. case temp.

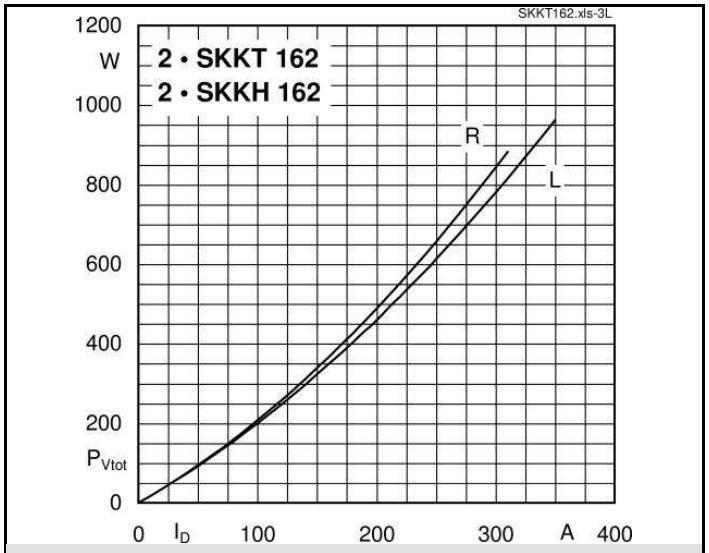

Fig. 3L Power dissipation of two modules vs. direct current

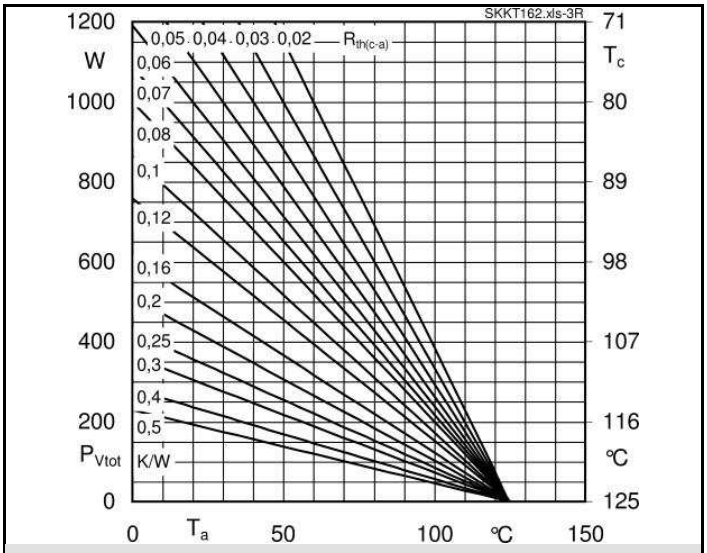

Fig. 3R Power dissipation of two modules vs. case temp.

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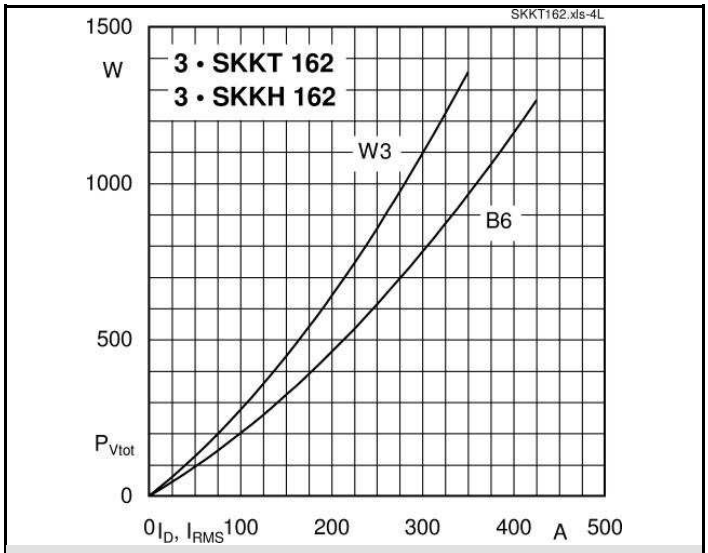

Fig. 4L Power dissipation of three modules vs. direct and rms current

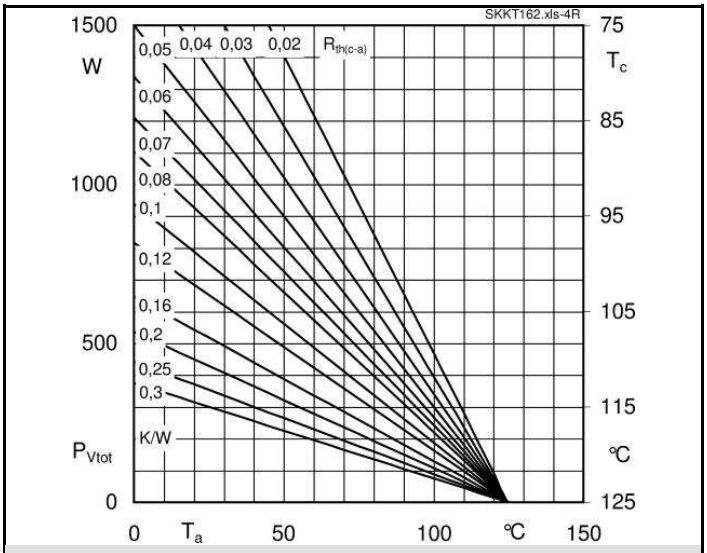

Fig. 4R Power dissipation of three modules vs. case temp.

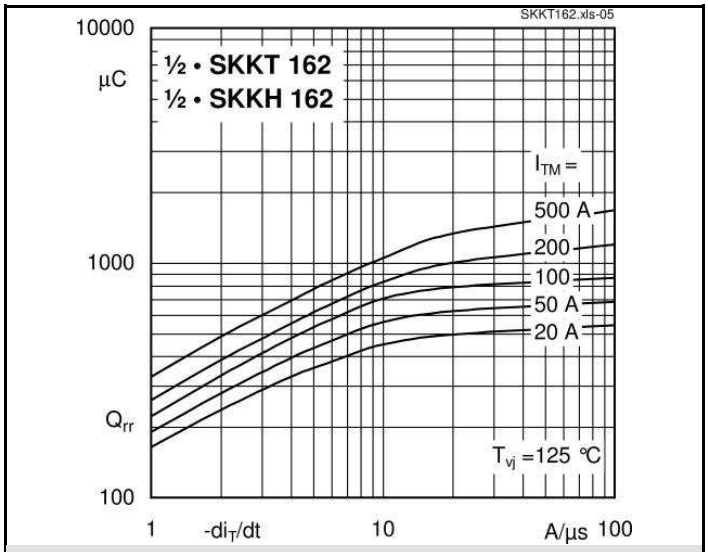

Fig. 5 Recovered charge vs. current decrease

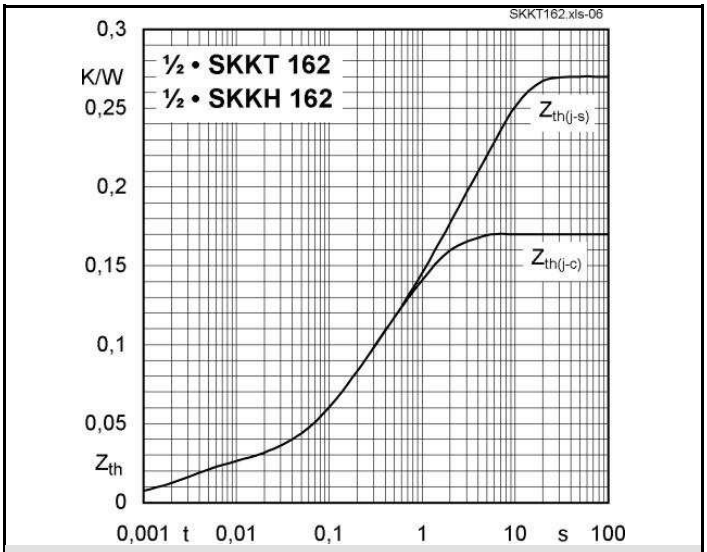

Fig. 6 Transient thermal impedance vs. time

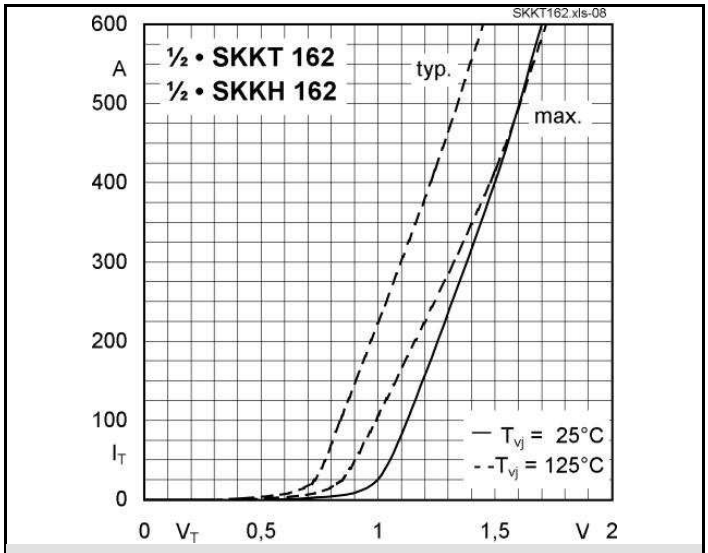

Fig. 7 On-state characteristics

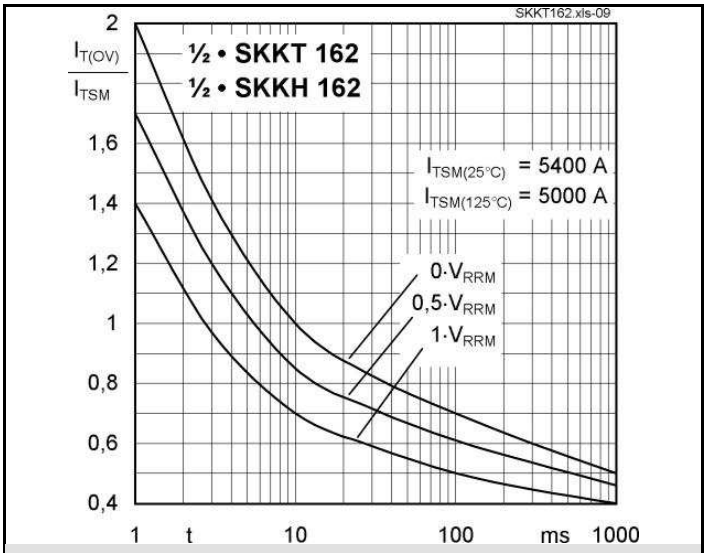

Fig. 8 Surge overload current vs. time

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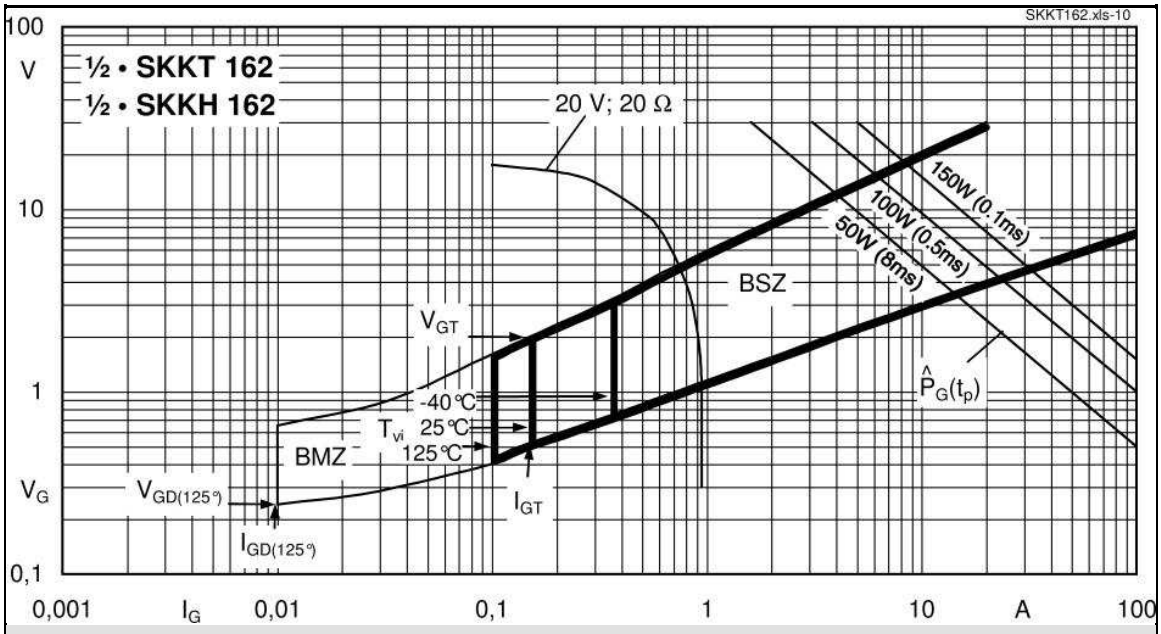
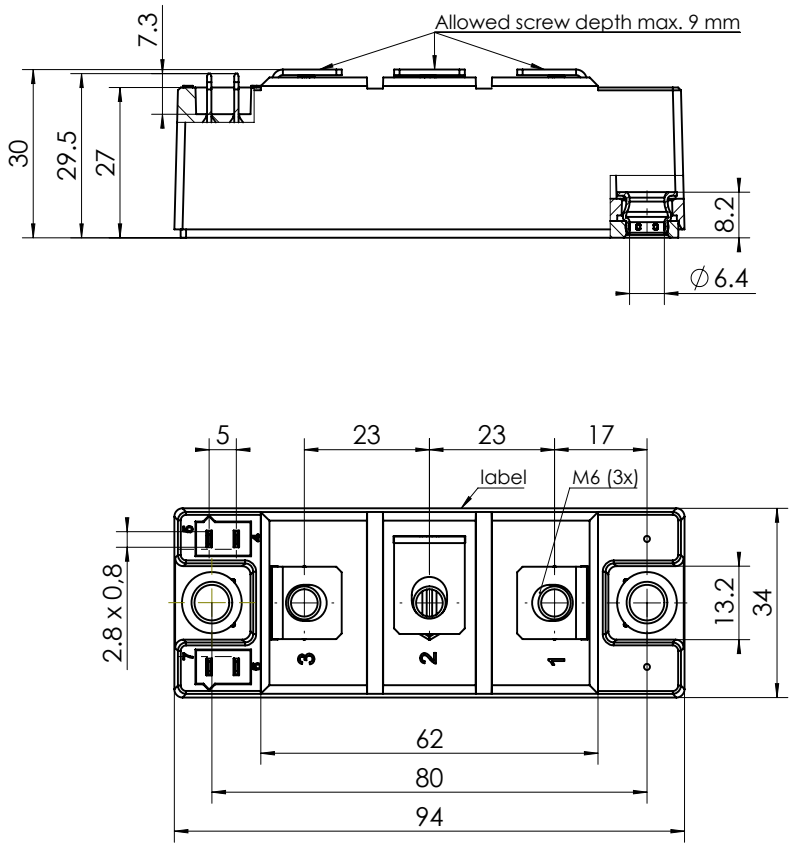
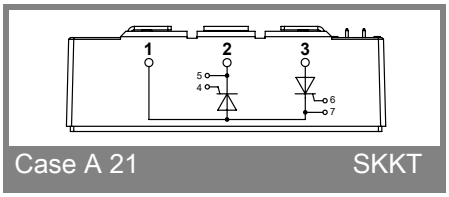


Fig. 9 Gate trigger characteristics

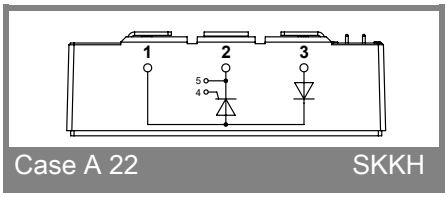
Dimensions in mm
General tolerance ±0.5 mm



SEMIPACK 2



Case A 21 SKKT



Case A 22 SKKH

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IMPORTANT INFORMATION AND WARNINGS

This is an electrostatic discharge sensitive device (ESDS) according to international standard IEC 61340.

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